

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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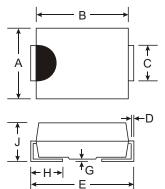
3.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER

Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 100A Peak
- Ideally Suited for Automatic Assembly
- Available in Lead Free Finish/RoHS Compliant Version (Note 3)

Mechanical Data

- Case: SMB/SMC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture sensitivity: Level 1 per J-STD-020C
- Terminals: Solder Plated Terminal Solderable per MIL-STD-202, Method 208
- Also Available in Lead Free Plating (Matte Tin Finish). Please see Ordering Information, Note 5, on Page 2
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number & Date Code, See Page 2
- Ordering Information: See Page 2
- Weight: SMB 0.093 grams (approximate) SMC 0.21 grams (approximate)



Dim	SI	ИB	SMC		
	Min	Max	Min	Max	
Α	3.30	3.94	5.59	6.22	
В	4.06	4.57	6.60	7.11	
С	1.96	2.21	2.75	3.18	
D	0.15	0.31	0.15	0.31	
Е	5.00	5.59	7.75	8.13	
G	0.10	0.20	0.10	0.20	
Н	0.76	1.52	0.76	1.52	
J	2.00	2.62	2.00	2.62	
All Dimensions in mm					

AB, BB, DB, GB, JB, KB, MB Suffix Designates SMB Package A, B, D, G, J, K, M Designates SMC Package

@ T_A = 25°C unless otherwise specified **Maximum Ratings and Electrical Characteristics**

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	S3 A/AB	S3 B/BB	S3 D/DB	S3 G/GB	S3 J/JB	S3 K/KB	S3 M/MB	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	٧
RMS Reverse Voltage		V _{R(RMS)}	30	70	140	280	420	560	700	V
Average Rectified Output Current	@ T _T = 75°C	Io		•	•	3.0		•		Α
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)		I _{FSM}	100					Α		
Forward Voltage	@ I _F = 3.0A	V _{FM}	1.15			V				
Peak Reverse Current at Rated DC Blocking Voltage	@ T _A = 25°C @ T _A = 125 °C					10 250				μΑ
Typical Total Capacitance (Note 1)		Ст	40					pF		
Typical Thermal Resistance Junction to Terminal (Note 2)		$R_{\theta JT}$	10					°C/W		
Operating and Storage Temperature Range		T _{j,} T _{STG}	-65 to +150					°C		

Notes:

- 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
- 2. Thermal resistance: Junction to Terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pad as heat sink.
- 3. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.



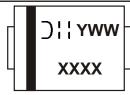
Ordering Information (Note 4)

Device*	Packaging	Shipping
S3xB-13 S3x-13	SMB SMC	3000/Tape & Reel

^{*}x = Device type, e.g. S3AB-13 (SMB package); S3A-13 (SMC Package).

- 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
- 5. For Lead Free Finish; RoHS Compliant version part numbers, please add "-F" suffix to the part numbers above. Example: S3AB-13-F.

Marking Information

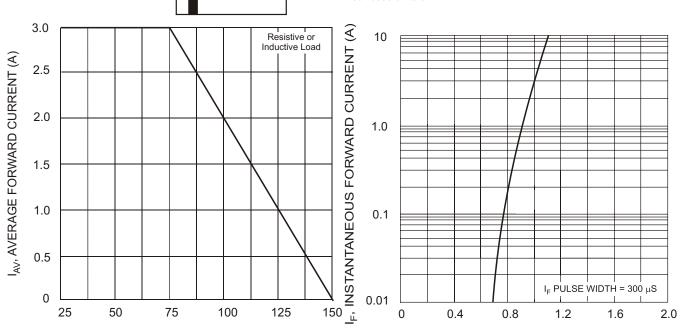


XXXX = Product type marking code, ex. S5KC

III = Manufacturers' code marking

YWW = Date code marking Y = Last digit of year ex: 2 for 2002

WW = Week code 01 to 52

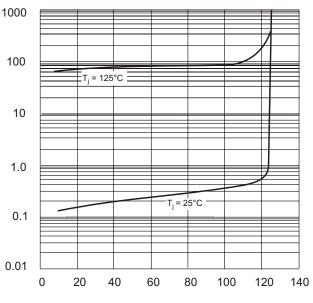


T_T, TERMINAL TEMPERATURE (°C)

Fig. 1 Forward Current Derating Curve 120 Single Half-Sine-Wave INSTANTANEOUS REVERSE CURRENT (µA) I_{FSM}, PEAK FORWARD SURGE CURRENT (A) JEDEC Method 100 80 60 40 20 č 0 10 100 1 NUMBER OF CYCLES AT 60 Hz

Fig. 3 Forward Surge Current Derating Curve

V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics



PERCENT OF RATED PEAK REVERSE VOLTAGE (%) Fig. 4 Typical Reverse Characteristics